onsemi

MOSFET - Power, DUAL COOL[®] N-Channel, DFN8 5x6

60 V, 1.5 mΩ, 235 A NTMFSC1D6N06CL

Features

- Advanced Dual-sided Cooled Packaging
- Ulra Low R_{DS(on)}
- MSL1 Robust Packaging Design

Typical Applications

- Orring FET/Load Switching
- Synchronous Rectifier
- DC-DC Conversion

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

| Parameter | | | Symbol | Value | Unit |
|---|---------------------------------------|-----------------------------------|-----------------|-------|------|
| Drain-to-Source Voltage | | V _{DSS} | 60 | V | |
| Gate-to-Source Voltage | Gate-to-Source Voltage | | V _{GS} | ±20 | V |
| Continuous Drain Current $R_{\theta JC}$ (Note 2) | Steady T _C = 25°C State | | ۱ _D | 235 | A |
| Power Dissipation $R_{\theta JC}$ (Note 2) | | | PD | 166 | W |
| Continuous Drain Current R _{θJA} (Notes 1, 2) | Steady State | T _A = 25°C | ۱ _D | 36 | A |
| Power Dissipation $R_{\theta JA}$ (Notes 1, 2) | | | PD | 3.8 | W |
| Pulsed Drain Current | $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ | | I _{DM} | 900 | А |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | –55 to +175 | °C | |
| Source Current (Body Diode) | | IS | 164 | А | |
| Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 17 A$) | | E _{AS} | 451 | mJ | |
| Lead Temperature Soldering Reflow for Solder- ing Purposes (1/8" from case for 10 s) | | ΤL | 300 | °C | |
| | | | | | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

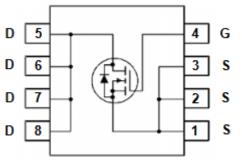
| Parameter | Symbol | Value | Unit |
|---|-----------------|-------|------|
| Junction-to-Case - Steady State (Note 2) | $R_{\theta JC}$ | 0.9 | °C/W |
| Junction-to-Top Source - Steady State (Note 2) | $R_{\theta JC}$ | 1.4 | |
| Junction-to-Ambient - Steady State (Note 2) | $R_{\theta JA}$ | 39 | |

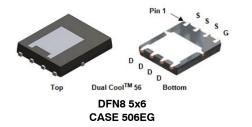
1. Surface-mounted on FR4 board using a 1 in² pad size, 1 oz Cu pad.

The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

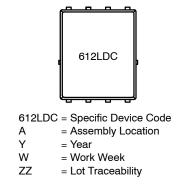
| V _{(BR)DSS} | R _{DS(ON)} MAX | I _D MAX | |
|----------------------|---|--------------------|--|
| 60 V | 1.5 m Ω @ 10 V | 235 A | |
| | $2.3~\mathrm{m}\Omega$ @ $4.5~\mathrm{V}$ | 233 A | |

N–Channel MOSFET





MARKING DIAGRAM



ORDERING INFORMATION

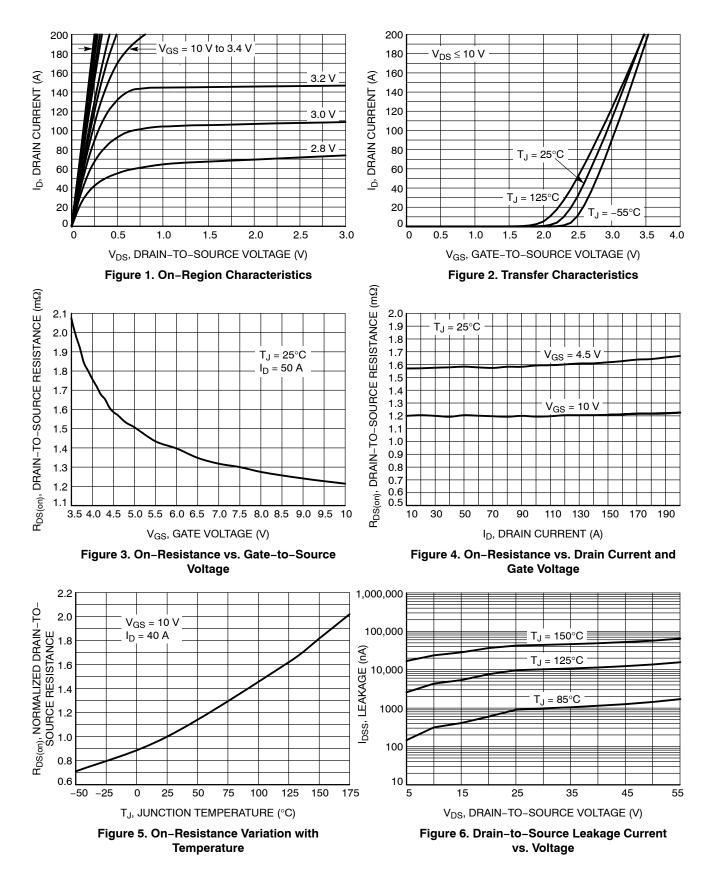
See detailed ordering and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

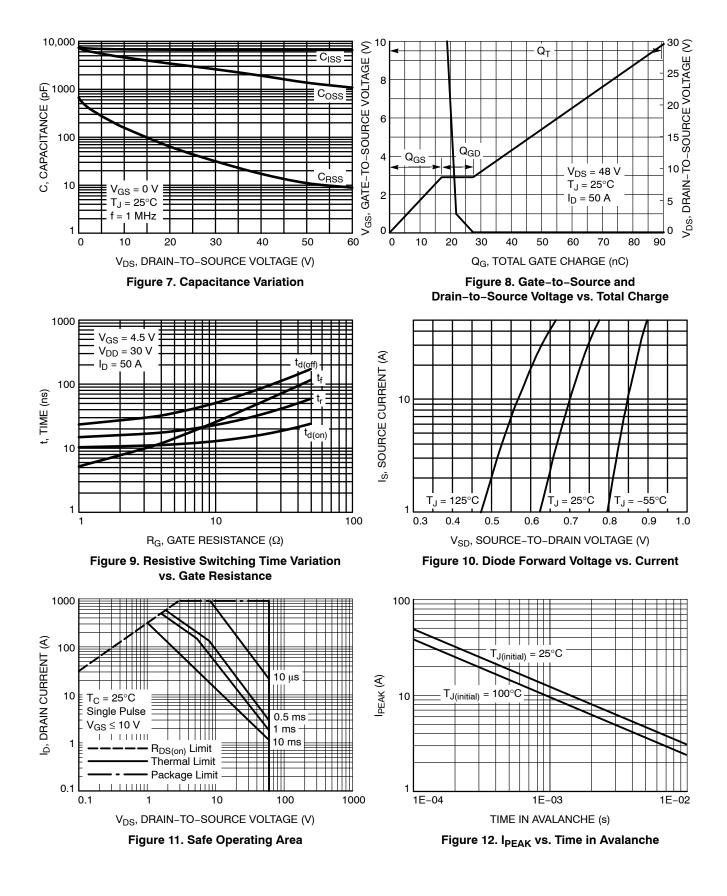
| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit |
|--|--|--|---|-----|------|-----------|-------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | V_{GS} = 0 V, I _D = | 250 μΑ | 60 | | | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} / T _J | $I_D = 250 \ \mu A$, ref to $25^{\circ}C$ | | | 12.7 | | mV/°C |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V, V _{DS} = 60 V | T _J = 25°C T _J = 125°C | | | 10 100 | μΑ |
| Gate-to-Source Leakage Current | I _{GSS} | V _{DS} = 0 V, V _{GS} | = 20 V | | | 100 | nA |
| ON CHARACTERISTICS (Note 3) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | V _{GS} = V _{DS} , I _D = | = 250 μA | 1.2 | | 2.0 | V |
| Negative Threshold Temperature Coefficient | V _{GS(TH)} /T _J | I _D = 250 μA, ref | to 25°C | | -5.8 | | mV/°C |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 50 A | | 1.25 | 1.5 | mΩ |
| | | V _{GS} = 4.5 V | I _D = 50 A | | 1.65 | 2.3 | |
| Gate-Resistance | R _G | T _A = 25° | С | | 2 | | Ω |
| CHARGES & CAPACITANCES | | | | | | - | |
| Input Capacitance | C _{ISS} | V_{GS} = 0 V, f = 1 MHz, V_{DS} = 25 V | | | 6660 | | pF |
| Output Capacitance | C _{OSS} | | | | 3000 | | |
| Reverse Transfer Capacitance | C _{RSS} | | | | 45 | | |
| Total Gate Charge | Q _{G(TOT)} | V_{GS} = 4.5 V, V_{DS} = 30 V, I_{D} = 50 A | | | 41 | | nC |
| Total Gate Charge | Q _{G(TOT)} | V _{GS} = 10 V, V _{DS} = 30 V, I _D = 50 A | | | 91 | | |
| Gate-to-Source Charge | Q _{GS} | | | | 17 | | |
| Gate-to-Drain Charge | Q _{GD} | | | | 9 | | |
| Plateau Voltage | V _{GP} | | | | 2.9 | | V |
| SWITCHING CHARACTERISTICS (Note 3) | | | | | | | |
| Turn-On Delay Time | t _{d(ON)} | V_{GS} = 10 V, V_{DS} = 48 V, I_{D} = 50 A, R_{G} = 1 Ω | | | 14.5 | | ns |
| Rise Time | t _r | | | | 55.6 | | |
| Turn-Off Delay Time | t _{d(OFF)} | | | | 47.5 | | |
| Fall Time | t _f | | | | 14.1 | | |
| DRAIN-SOURCE DIODE CHARACTERISTICS | 3 | | | | | | |
| Forward Diode Voltage | V _{SD} | | | | 0.78 | 1.2 | V |
| | | $I_{\rm S} = 50 \text{ A}$ $T_{\rm J} = 125^{\circ} \text{C}$ | 0.66 | | 1 | | |
| Reverse Recovery Time | t _{RR} | V _{GS} = 0 V, dI _S /dt = 100 A/μs, | | | 76 | | ns |
| Reverse Recovery Charge | Q _{RR} | I _S = 50 A | N N | | 130 | | nC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.3. Switching characteristics are independent of operating junction temperatures.

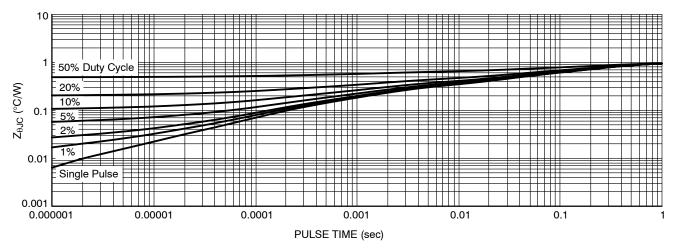
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



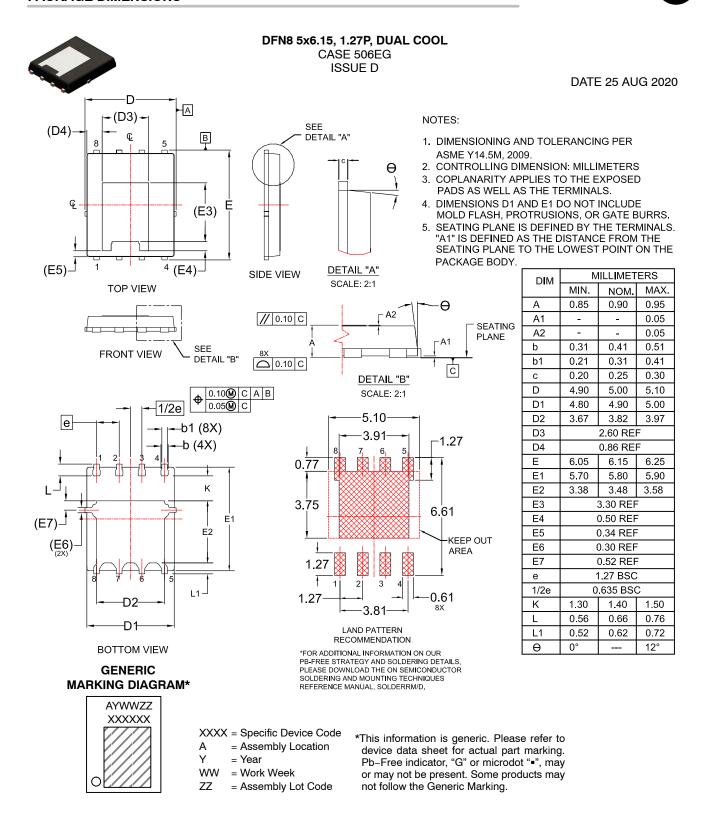


ORDERING INFORMATION

| Device | Device Marking | Package | Shipping [†] |
|----------------|----------------|------------------------------------|-----------------------|
| NTMFSC1D6N06CL | 612LDC | DFN8 5x6 (Pb–Free/Halogen Free) | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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|---------------------------------------|---|--|-------------|--|
| DESCRIPTION: | DFN8 5x6.15, 1.27P, DUAL COOL | | PAGE 1 OF 1 | |
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